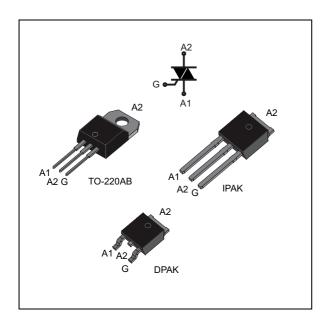


### 4 A Triacs

Datasheet - production data



#### **Features**

- Three quadrants Triac
- 600 to 800 V V<sub>DRM</sub>/V<sub>RRM</sub>

## **Applications**

- General purpose AC inductive loads
- · Motor control circuits
- Small home appliances

### **Description**

Based on ST's Snubberless / logic level technology providing high commutation performances, the T4 series is suitable for use on AC inductive loads. They are recommended for applications using universal motors, electro valves, kitchen aid equipments, power tools, and dishwashers.

**Table 1. Main characteristics** 

Symbol	Value	Unit	
I <sub>T(rms)</sub>	4	Α	
$V_{DRM}, V_{RRM}$	600 to 800	V	
I <sub>GT</sub>	5 to 35	mA	

Table 2. Device summary

Symbol <sup>(1)</sup>	Marking
T405-xxxB	
T405-xxxB-TR	
T405-xxxH	
T405-xxxT	
T410-xxxB	
T410-xxxB-TR	see <i>Table 11</i>
T410-xxxH	See Table 11
T410-xxxT	
T435-xxxB	
T435-xxxB-TR	
T435-xxxH	
T435-xxxT	

1. xxx = Voltage: 600 V, 700 V or 800 V (see *Table 10*).

Characteristics T4 series

## 1 Characteristics

Table 3. Absolute maximum ratings ( $T_j = 25$  °C unless otherwise stated)

Symbol	Paramo	eter		Value	Unit
I <sub>T(rms)</sub>	On-state rms current (full sine wave)			4	Α
1.	Non repetitive surge peak on-state	F = 50 Hz	t = 20 ms	30	Α
I <sub>TSM</sub>	current (full cycle, T <sub>j</sub> initial = 25 °C)	F = 60 Hz	t = 16.7 ms	31	A
l <sup>2</sup> t	I <sup>2</sup> t value for fusing		t <sub>p</sub> = 10 ms	5.1	A²s
dI/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$ , $t_r \le 100 \text{ ns}$	F = 120 Hz	T <sub>j</sub> = 125 °C	50	A/µs
I <sub>GM</sub>	Peak gate current	t <sub>p</sub> = 20 μs	T <sub>j</sub> = 125 °C	4	Α
P <sub>G(AV)</sub>	Average gate power dissipation	1	W		
T <sub>stg</sub> T <sub>j</sub>	Storage junction temperature range Operating junction temperature rang	- 40 to +150 - 40 to +125	°C		

Table 4. Electrical characteristics ( $T_j = 25$  °C, unless otherwise stated)

Symbol	Test conditions	Quadrant		Value			Unit
Symbol	rest conditions	Quadrant		T405	T410	T435	
I <sub>GT</sub> <sup>(1)</sup>	$V_D = 12 \text{ V}, R_L = 30 \Omega$	1 - 11 - 111	Max.	5	10	35	mA
$V_{GT}$	$V_D = 12 \text{ V}, R_L = 30 \Omega$	1 - 11 - 111	Max.	1.3			V
V <sub>GD</sub>	$V_D = V_{DRM}, R_L = 3.3 \text{ k} \Omega, T_j = 125 \text{ °C}$	1 - 11 - 111	Min.	0.2			V
I <sub>H</sub> <sup>(2)</sup>	I <sub>T</sub> = 100 mA	•	Max.	10	15	35	mA
1	I <sub>G</sub> = 1.2 I <sub>GT</sub>	1 - 111	Max.	10	25	50	mA
IL	IG = 1.2 IGT	II	Max.	15	30	60	ША
dV/dt (2)	$V_D = 67\% V_{DRM}$ , gate open	T <sub>j</sub> = 125 °C	Min.	20	40	400	V/µs
	(dV/dt)c = 0.1 V/μs			1.8	2.7		
(dl/dt)c (2)	(dV/dt)c = 10 V/µs	T <sub>j</sub> = 125 °C	Min.	0.9	2.0		A/ms
	(without snubber)					2.5	

<sup>1.</sup> Minimum  $I_{GT}$  is guaranteed at 5% of  $I_{GT}$  max.

<sup>2.</sup> For both polarities of A2 referenced to A1

T4 series Characteristics

**Table 5. Static characteristics** 

Symbol	Test co	Value	Unit		
V <sub>TM</sub> <sup>(1)</sup>	$I_{TM} = 5.5 \text{ A}, t_p = 380 \ \mu\text{s}$	T <sub>j</sub> = 25 °C	Max.	1.56	V
V <sub>t0</sub> (1)	Threshold voltage	T <sub>j</sub> = 125 °C	Max.	0.89	V
R <sub>d</sub> <sup>(1)</sup>	Dynamic resistance	T <sub>j</sub> = 125 °C	Max.	120	mΩ
I <sub>DRM</sub>	\/ _\/	T <sub>j</sub> = 25 °C	Max.	5	μΑ
$I_{RRM}$	$V_{DRM} = V_{RRM}$	T <sub>j</sub> = 125 °C	iviax.	1	mA

<sup>1.</sup> For both polarities of A2 referenced to A1

Table 6. Thermal resistance

Symbol		Value	Unit		
R <sub>th(j-c)</sub>	Junction to case (AC)		IPAK, DPAK,TO-220AB	2.6	°C/W
	Junction to ambient	$S^{(1)} = 0.5 \text{ cm}^2$	DPAK	70	°C/W
R <sub>th(j-a)</sub>	R <sub>th(j-a)</sub> Junction to ambient		TO-220AB	60	°C/W
			IPAK	100	°C/W

<sup>1.</sup> S = Copper surface under tab.

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Characteristics T4 series

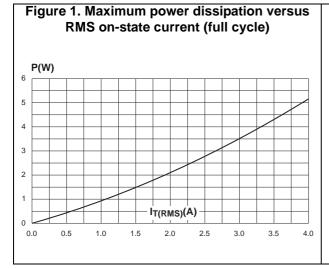


Figure 2. RMS on-state current versus case temperature (full cycle)  $I_{T(RMS)}(A)$ 4.0 TO-220AB / DPAK / IPAK 3.5 3.0 2.5 2.0 1.5 1.0 0.5 T<sub>C</sub>(°C) 0.0 25 50 75 100 125 0

Figure 3. RMS on-state current versus ambient temperature (printed circuit board FR4, copper thickness: 35µm) (full cycle)

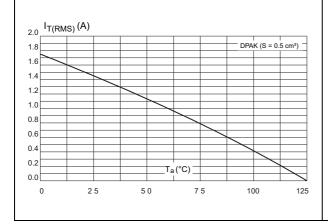


Figure 4. Relative variation of thermal impedance versus pulse duration

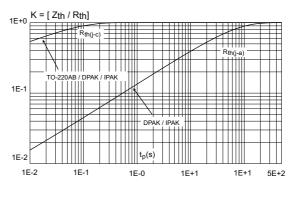


Figure 5. On-state characteristics (maximum values)

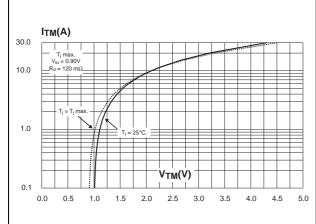
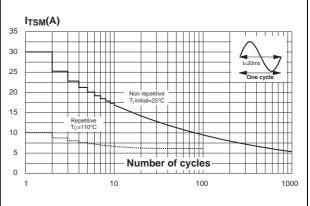


Figure 6. Surge peak on-state current versus number of cycles



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T4 series Characteristics

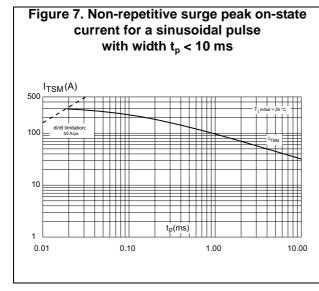


Figure 8. Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values)

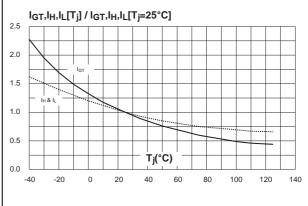


Figure 9. Relative variation of critical rate of decrease of main current versus (dV/dt)c (typical values)

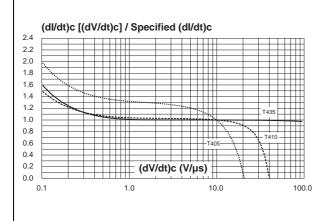


Figure 10. Relative variation of critical rate of decrease of main current versus junction temperature

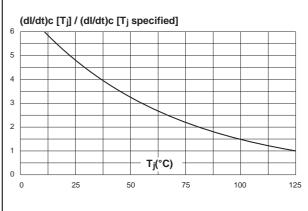
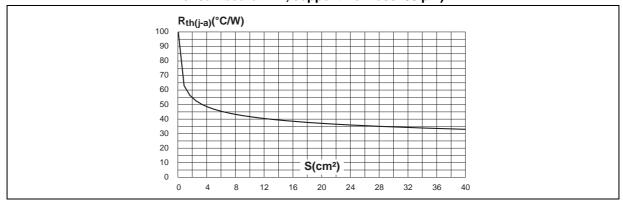


Figure 11. DPAK thermal resistance junction to ambient versus copper surface under tab (printed circuit board FR4, copper thickness: 35 μm)





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**Package information** T4 series

#### 2 **Package information**

- Molding epoxy meets UL94, V0 and is halogen free
- Lead-free package
- Recommended torque: 0.4 to 0.6 N·m for TO-220AB

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK<sup>®</sup> is an ST trademark.

#### **DPAK** package information 2.1

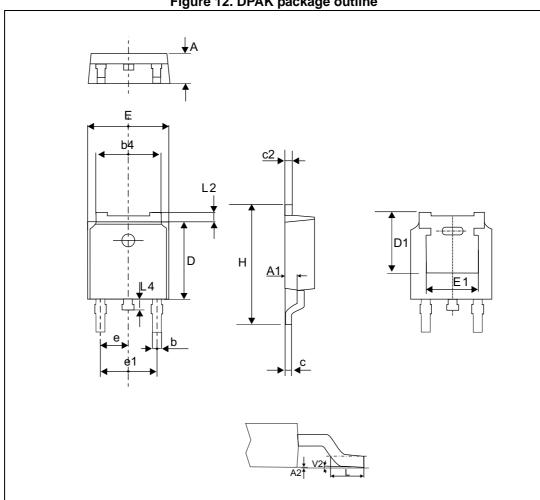


Figure 12. DPAK package outline

Note:

Downloaded from Arrow.com.

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

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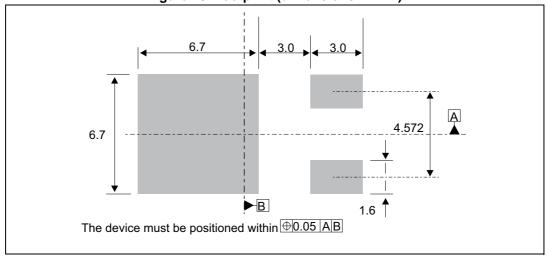
T4 series Package information

Table 7. DPAK package mechanical data

		Dimensions							
Ref.		Millimeters			Inches <sup>(1)</sup>				
	Min.	Тур.	Max.	Min.	Тур.	Max.			
Α	2.18		2.40	0.086		0.0944			
A1	0.9		1.10	0.035		0.0433			
A2	0.03		0.23	0.0011		0.0090			
b	0.64		0.90	0.0251		0.0354			
b4	4.95		5.46	0.1948		0.2149			
С	0.46		0.61	0.0181		0.0240			
c2	0.46		0.60	0.0181		0.0236			
D	5.97		6.22	0.2350		0.2448			
D1	4.95			0.1948					
E	6.35		6.73	0.2500		0.2649			
E1	4.32			0.1700					
е		2.286			0.09				
e1		4.572			0.18				
Н	9.35		10.40	0.3681		0.4094			
L	1.0		1.78	0.039		0.0700			
L2			1.27			0.0500			
L4	0.6		1.02	0.023		0.0401			
V2	-8°		+8°	-8°		+8°			

<sup>1.</sup> Inch dimensions are only for reference

Figure 13. Footprint (dimensions in mm)



Package information T4 series

## 2.2 IPAK package information

 $\begin{array}{c|c} E \\ b4 \\ \hline \end{array}$ 

Figure 14. IPAK package outline

Note:

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Table 8. IPAK package mechanical data

		Dimensions							
Ref.		Millimeters		Inches <sup>(1)</sup>					
	Min.	Тур.	Max.	Min.	Тур.	Max.			
Α	2.20		2.40	0.0866		0.0945			
A1	0.90		1.10	0.0354		0.0433			
b	0.64		0.90	0.0252		0.0354			
b2			0.95			0.0374			
b4	5.20		5.43	0.2047		0.2138			
С	0.45		0.60	0.0177		0.0236			
c2	0.46		0.60	0.0181		0.0236			
D	6		6.20	0.2362		0.2441			
E	6.40		6.65	0.2520		0.2618			
е		2.28			0.0898				
e1	4.40		4.60	0.1732		0.1811			
Н		16.10			0.6339				
L	9		9.60	0.3543		0.3780			
L1	0.8		1.20	0.0315		0.0472			
L2		0.80	1.25		0.0315	0.0492			
V1		10°			10°				

<sup>1.</sup> Inch dimensions are only for reference

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Package information T4 series

## 2.3 TO-220AB (insulated and non-insulated) information

В С ØΙ b2 ↑ L Α 14 13 c2 a1 12 a2 M с1 b1

Figure 15. TO-220AB (insulated and non-insulated) package outline

T4 series Package information

Table 9. TO-220AB (insulated and non-insulated) package mechanical data

	Dimensions									
Ref.		Millimeters			Inches <sup>(1)</sup>					
	Min.	Тур.	Max.	Min.	Тур.	Max.				
А	15.20		15.90	0.5984		0.6259				
a1		3.75			0.1476					
a2	13.00		14.00	0.5118		0.5511				
В	10.00		10.40	0.3937		0.4094				
b1	0.61		0.88	0.0240		0.0346				
b2	1.23		1.32	0.0484		0.0519				
С	4.40		4.60	0.1732		0.1811				
c1	0.49		0.70	0.0192		0.0275				
c2	2.40		2.72	0.0944		0.1070				
е	2.40		2.70	0.0944		0.1062				
F	6.20		6.60	0.2440		0.2598				
ØI	3.73		3.88	0.1468		0.1527				
14	15.80	16.40	16.80	0.6220	0.6456	0.6614				
L	2.65		2.95	0.1043		0.1161				
12	1.14		1.70	0.0448		0.0669				
13	1.14		1.70	0.0448		0.0669				
М		2.60			0.1023					

<sup>1.</sup> Inch dimensions are only for reference

Ordering information T4 series

# 3 Ordering information

Figure 16. Order information scheme

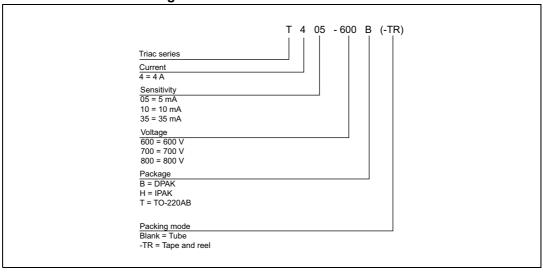


Table 10. Product selector

Part number	Voltage (xxx)			Sensitivity	Typo	Package
rait ilullibei	600 V	700 V	800 V	Sensitivity	Туре	Fackage
T405-xxxB	Χ			5 mA	Logic level	DPAK
T405-xxxB-TR	Х	Х	Х	5 mA	Logic level	DPAK
T405-xxxH	Х		Х	5 mA	Logic level	IPAK
T405-xxxT	Х			5 mA	Logic level	TO-220AB
T410-xxxB	Х			10 mA	Logic level	DPAK
T410-xxxB-TR	Х		Х	10 mA	Logic level	DPAK
T410-xxxH	Х		Х	10 mA	Logic level	IPAK
T410-xxxT	Х	Х	Х	10 mA	Logic level	TO-220AB
T435-xxxB	Х			35 mA	Snubberless	DPAK
T435-xxxB-TR	Х	Х	Х	35 mA	Snubberless	DPAK
T435-xxxH	Х		Х	35 mA	Snubberless	IPAK
T435-xxxT	Х		Х	35 mA	Snubberless	TO-220AB

Blank = Unavailable

**Table 11. Ordering information** 

Table 11. Ordering information							
Order code	Marking	Package	Weight	Base qty.	Delivery mode		
T405-600B	T4 0560						
T410-600B	T4 1060			75	Tube		
T435-600B	T4 3560						
T405-600B-TR	T4 0560						
T410-600B-TR	T4 1060						
T435-600B-TR	T4 3560	DPAK	0.3 g				
T405-700B-TR	T4 0570			2500	Tape and reel		
T435-700B-TR	T4 3570			2500	Tape and reer		
T405-800B-TR	T4 0580						
T410-800B-TR	T4 1080						
T435-800B-TR	T4 3580						
T405-600H	T4 0560						
T410-600H	T4 1060						
T435-600H	T4 3560	IPAK	0.4 =	75			
T405-800H	T4 0580	IPAK	0.4 g	75			
T410-800H	T4 1080						
T435-800H	T4 3580				Tube		
T405-600T	T405-600T				rube		
T410-600T	T410-600T						
T435-600T	T435-600T	TO 220AF	2.2 =	50			
T410-700T	T410-700T	TO-220AB	2.3 g	50			
T410-800T	T410-800T						
T435-800T	T435-800T						

Revision history T4 series

# 4 Revision history

**Table 12. Document revision history** 

Date	Revision	Changes
Jun-2003	2	Last updated.
25-Mar-2005	3	Layout updated, No content change.
25-Jan-2006	4	Markings changed in Table 12.
14-May-2014	5	Updated DPAK and IPAK package information and reformatted to current standard.
11-Feb-2015	6	Updated package silhouettes in cover page.
1-Apr-2016	7	Removed ISOWATT-220AB package information.
05-Oct-2016	8	Updated Table 3 and Table 11. Updated Figure 2 and Figure 4.
14-Nov-2016	9	Updated Table 1.

#### T4 series

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